

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	214	257/794.ccls.	USPAT; US-PGPUB
2	BRS	L2	295	257/702.ccls.	USPAT; US-PGPUB
3	BRS	L3	414	257/730.ccls.	USPAT; US-PGPUB
4	BRS	L4	678	257/707.ccls.	USPAT; US-PGPUB
5	BRS	L5	921	257/706.ccls.	USPAT; US-PGPUB
6	BRS	L6	849	257/713.ccls.	USPAT; US-PGPUB
7	BRS	L7	387	257/680.ccls.	USPAT; US-PGPUB
8	BRS	L8	354	257/785.ccls.	USPAT; US-PGPUB
9	BRS	L9	1614	Chip adj scale adj package	USPAT; US-PGPUB
10	BRS	L10	50	Wafer adj scale adj package	USPAT; US-PGPUB
11	BRS	L11	446	257/E23.009.ccls.	USPAT; US-PGPUB
12	BRS	L12	724	257/E23.065.ccls.	USPAT; US-PGPUB
13	BRS	L13	712	257/E23.125.ccls.	USPAT; US-PGPUB
14	BRS	L14	177	257/794.ccls.	EPO; JPO; IBM TDB
15	BRS	L15	136	257/702.ccls.	EPO; JPO; IBM TDB
16	BRS	L16	358	257/730.ccls.	EPO; JPO; IBM TDB
17	BRS	L17	77	Chip adj scale adj package	EPO; JPO; IBM TDB
18	BRS	L18	219	257/680.ccls.	EPO; JPO; IBM TDB
19	BRS	L19	671	257/701.ccls.	USPAT; US-PGPUB
20	BRS	L20	441	257/701.ccls.	EPO; JPO; IBM TDB
21	BRS	L21	727	438/124.ccls.	USPAT; US-PGPUB
22	BRS	L22	715	438/126.ccls.	USPAT; US-PGPUB
23	BRS	L23	1000	438/127.ccls.	USPAT; US-PGPUB
24	BRS	L24	119	L9 and (quartz or silica) and glass	USPAT; US-PGPUB
25	BRS	L28	10	L10 and (quartz or silica) and glass	USPAT; US-PGPUB
26	BRS	L26	14	L3 and (quartz or silica) and glass	USPAT; US-PGPUB

	Type	L #	Hits	Search Text	DBs
27	BRS	L25	35	L1 and (quartz or silica) and glass	USPAT; US-PGPUB
28	BRS	L27	37	L2 and (quartz or silica) and glass	USPAT; US-PGPUB